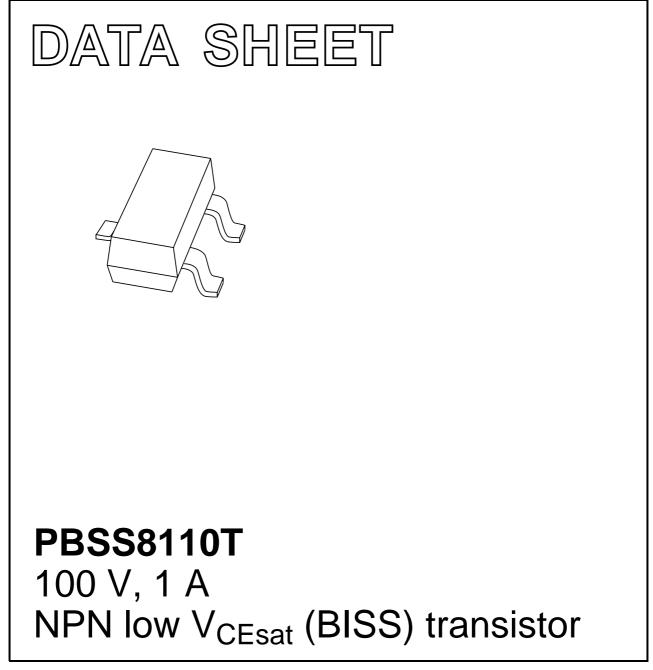
## DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2003 Jul 28 2003 Dec 22



**PBSS8110T** 

#### **NXP Semiconductors**

## 100 V, 1 A NPN Iow V<sub>CEsat</sub> (BISS) transistor

#### FEATURES

- SOT23 package
- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability: I<sub>C</sub> and I<sub>CM</sub>
- · Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

#### APPLICATIONS

- Major application segments
  - Automotive 42 V power
  - Telecom infrastructure
  - Industrial
- Power management
  - DC/DC converters
  - Supply line switching
  - Battery charger
  - LCD backlighting.
- Peripheral drivers
  - Driver in low supply voltage applications (e.g. lamps and LEDs).
  - Inductive load driver (e.g. relays, buzzers and motors).

#### DESCRIPTION

NPN low  $V_{CEsat}$  transistor in a SOT23 plastic package. PNP complement: PBSS9110T.

#### MARKING

TYPE NUMBER	MARKING CODE <sup>(1)</sup>
PBSS8110T	*U8

#### Note

- 1. \* = p : Made in Hong Kong.
  - \* = t : Made in Malaysia.
  - \* = W : Made in China.

#### **ORDERING INFORMATION**

TYPE NUMBER		PACKAGE		
	NAME DESCRIPTION VER		VERSION	
PBSS8110T	<ul> <li>plastic surface mounted package; 3 leads</li> </ul>		SOT23	

#### QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT	
V <sub>CEO</sub>	collector-emitter voltage	100	V	
I <sub>C</sub>	collector current (DC)	1	А	
I <sub>CM</sub>	repetitive peak collector current	3	A	
R <sub>CEsat</sub>	equivalent on-resistance	200	mΩ	

#### PINNING

PIN DESCRIPTION	
1	base
2	emitter
3	collector

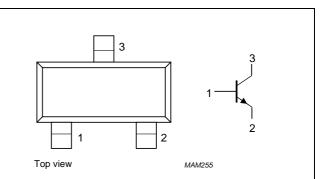


Fig.1 Simplified outline (SOT23) and symbol.

### PBSS8110T

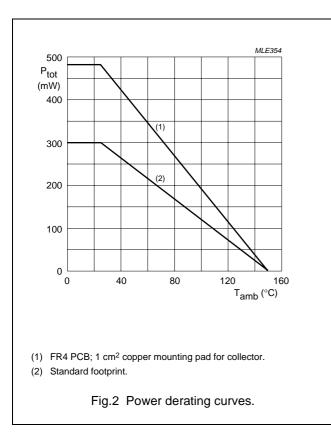
#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	-	120	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	100	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	5	V
I <sub>C</sub>	collector current (DC)		_	1	А
I <sub>CM</sub>	peak collector current	limited by T <sub>j max</sub>	_	3	А
IB	base current (DC)		_	300	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$ ; note 1	_	300	mW
		$T_{amb} \le 25 \ ^{\circ}C$ ; note 2	_	480	mW
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

#### Notes

- 1. Device mounted on a printed-circuit board, single sided copper, tinplated, standard footprint.
- 2. Device mounted on a printed-circuit board, single sided copper, tinplated, mounting pad for collector 1 cm<sup>2</sup>.



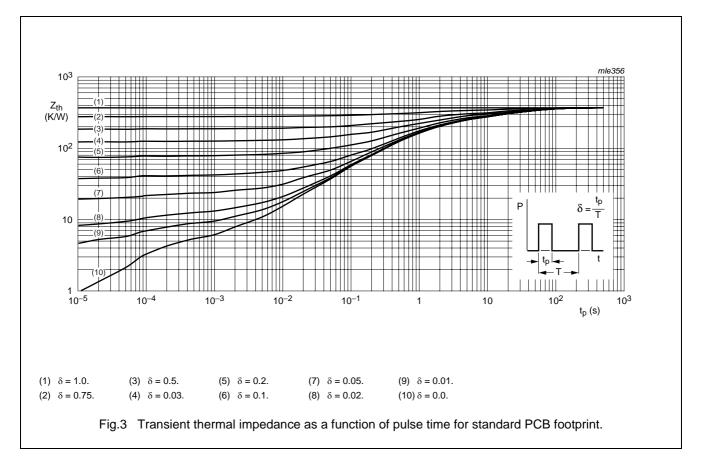
### PBSS8110T

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to	in free air; note 1	417	K/W
	ambient	in free air; note 2	260	K/W

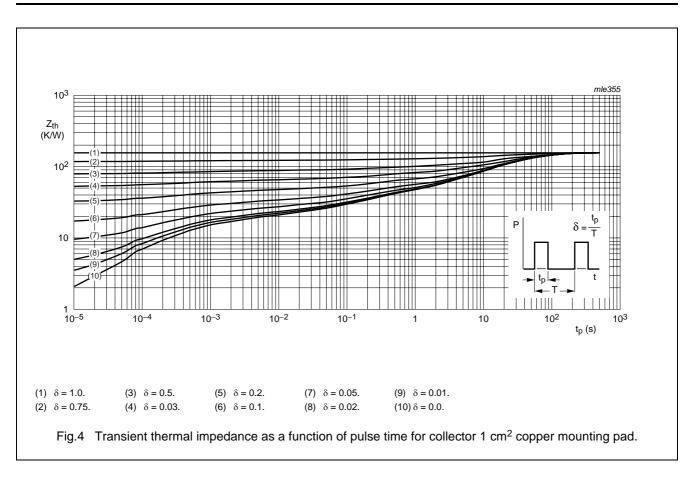
#### Notes

- 1. Device mounted on a printed-circuit board, single sided copper, tinplated and standard footprint.
- 2. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 1 cm<sup>2</sup>.



**PBSS8110T** 

# 100 V, 1 A NPN low $V_{CEsat}$ (BISS) transistor



### PBSS8110T

#### CHARACTERISTICS

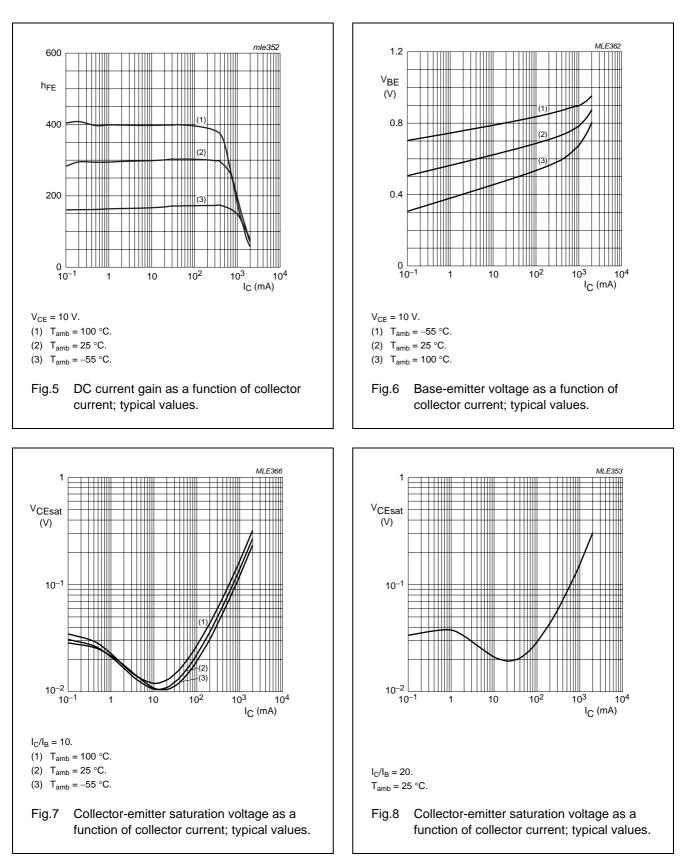
 $T_j$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 80 \text{ V}; \text{ I}_{E} = 0$	-	-	100	nA
		$V_{CB} = 80 \text{ V}; I_E = 0; T_j = 150 \text{ °C}$	-	-	50	μA
I <sub>CES</sub>	collector-emitter cut-off current	V <sub>CE</sub> = 80 V; V <sub>BE</sub> = 0	-	-	100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 4 \text{ V}; \text{ I}_{C} = 0$	_	-	100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 1 mA	150	-	-	
		V <sub>CE</sub> = 10 V; I <sub>C</sub> = 250 mA	150	-	500	
		$V_{CE} = 10 \text{ V}; \text{ I}_{C} = 500 \text{ mA}; \text{ note } 1$	100	-	-	
		$V_{CE} = 10 \text{ V}; I_{C} = 1 \text{ A}; \text{ note } 1$	80	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 100 mA; I <sub>B</sub> = 10 mA	-	-	40	mV
		I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA	-	-	120	mV
		I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA; note 1	-	_	200	mV
R <sub>CEsat</sub>	equivalent on-resistance	I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA; note 1	-	165	200	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA	-	_	1.05	V
V <sub>BEon</sub>	base-emitter turn-on voltage	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 1 A	-	_	0.9	V
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 50 mA; V <sub>CE</sub> = 10 V; f = 100 MHz	100	-	-	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{ I}_{e} = 0; \text{ f} = 1 \text{ MHz}$	_	_	7.5	pF

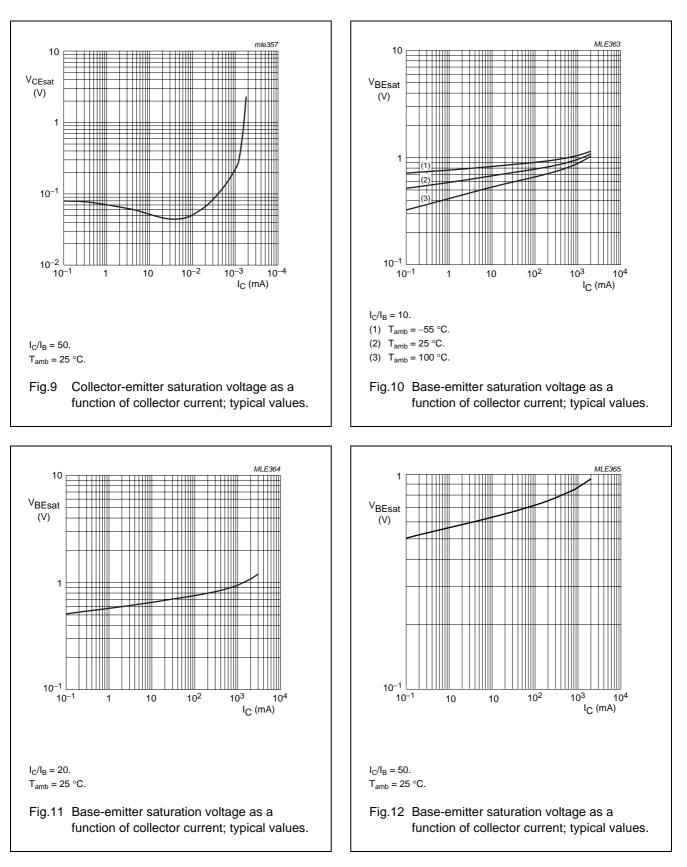
#### Note

1. Pulse test:  $t_p \leq 300~\mu s;~\delta \leq 0.02.$ 

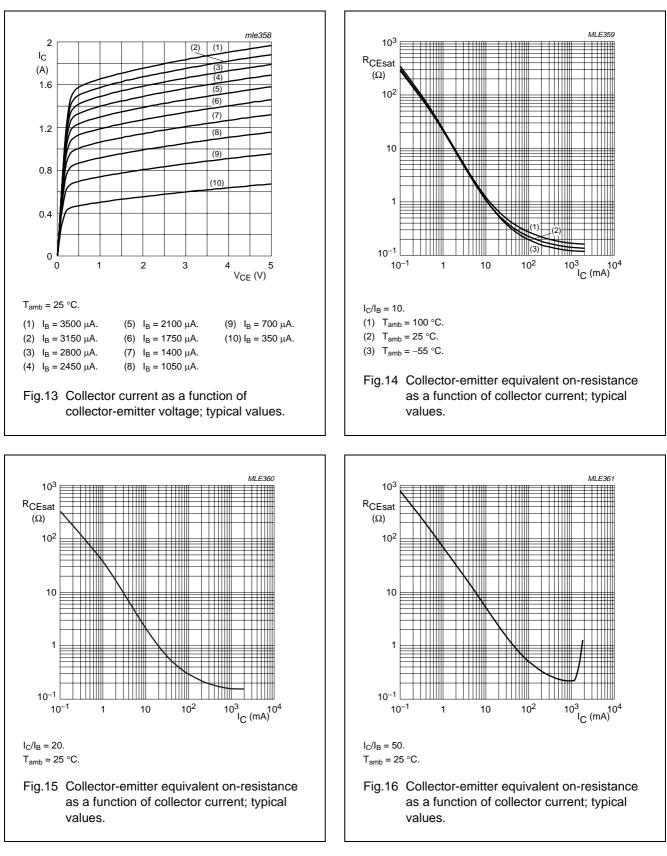
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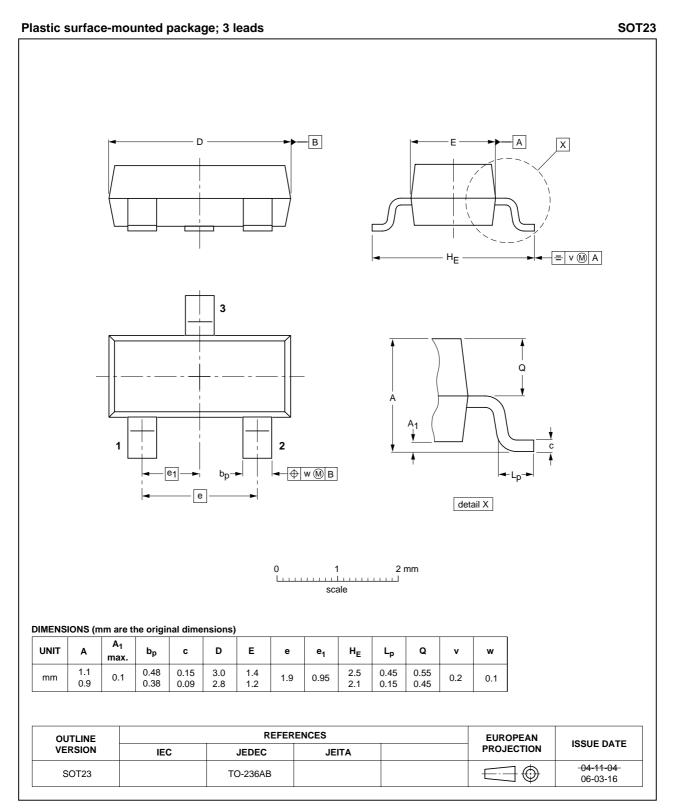
# PBSS8110T



## PBSS8110T



#### PACKAGE OUTLINE



### PBSS8110T

#### DATA SHEET STATUS

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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## **NXP Semiconductors**

#### **Customer notification**

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

#### **Contact information**

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